Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	V_{GE} = 0V, I_C = 0.50mA	1000	-	-	V
Collector-emitter saturation voltage	V_{CEsat}	V_{GE} = 15.0V, I_C = 30.0A T_{vj} = 25°C T_{vj} = 150°C T_{vj} = 175°C	 - - -	 1.55 1.70 1.80	 1.90 - -	V
Gate-emitter threshold voltage	$V_{GE(th)}$	I_C = 0.80mA, V_{CE} = V_{GE}	5.1	5.8	6.4	V
Zero gate voltage collector current	I_{CES}	V_{CE} = 1000V, V_{GE} = 0V T_{vj} = 25°C T_{vj} = 175°C	 - -	 - -	 50.0 2500.0	µA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0V, V_{GE} = 20V	-	-	600	nA
Transconductance	g_{fs}	V_{CE} = 20V, I_C = 30.0A	-	28.0	-	S
Integrated gate resistor	r_G			none		Ω

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Input capacitance	C_{iss}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz	-	3575	-	pF
Output capacitance	C_{oss}		-	98	-	
Reverse transfer capacitance	C_{rss}		-	76	-	
Gate charge	Q_G	V_{CC} = 800V, I_C = 30.0A, V_{GE} = 15V	-	217.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	13.0	-	nH

Switching Characteristic, Inductive Load, at T_{vj} = 25°C

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 25°C, V_{CC} = 600V, I_C = 30.0A, V_{GE} = 0.0/15.0V, r_G = 16.0Ω, L_σ = 105nH, C_σ = 50pF L_σ, C_σ from Fig. E Energy losses include “tail” and diode reverse recovery using the IKW30N100T duopak.	-	33	-	ns
Rise time	t_r		-	21	-	ns
Turn-off delay time	$t_{d(off)}$		-	535	-	ns
Fall time	t_f		-	34	-	ns
Turn-on energy	E_{on}		-	2.20	-	mJ
Turn-off energy	E_{off}		-	1.60	-	mJ
Total switching energy	E_{ts}		-	3.80	-	mJ

Switching Characteristic, Inductive Load, at T_{vj} = 175°C

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 175°C, V_{CC} = 600V, I_C = 30.0A, V_{GE} = 0.0/15.0V, r_G = 16.0Ω, L_σ = 105nH, C_σ = 50pF L_σ, C_σ from Fig. E Energy losses include “tail” and diode reverse recovery using the IKW30N100T duopak.	-	33	-	ns
Rise time	t_r		-	30	-	ns
Turn-off delay time	$t_{d(off)}$		-	610	-	ns
Fall time	t_f		-	60	-	ns
Turn-on energy	E_{on}		-	3.20	-	mJ
Turn-off energy	E_{off}		-	2.40	-	mJ
Total switching energy	E_{ts}		-	5.60	-	mJ

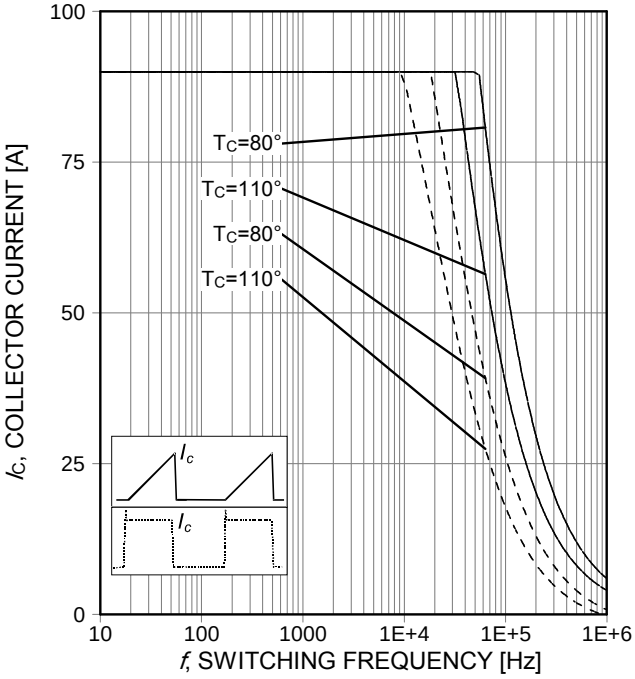

Figure 1. Collector current as a function of switching frequency
(T_j≤175°C, D=0.5, V_{CE}=600V, V_{GE}=15/0V, R_G=16Ω)

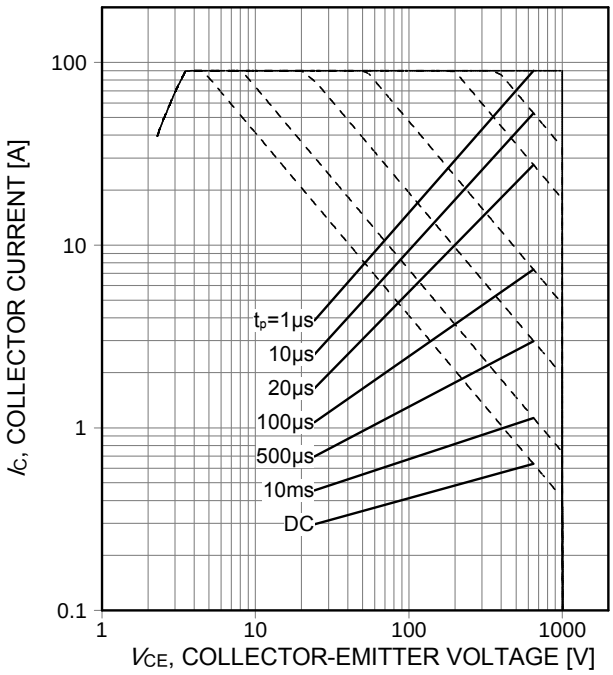

Figure 2. Forward bias safe operating area
(D=0, T_C=25°C, T_j≤175°C; V_{GE}=15V)

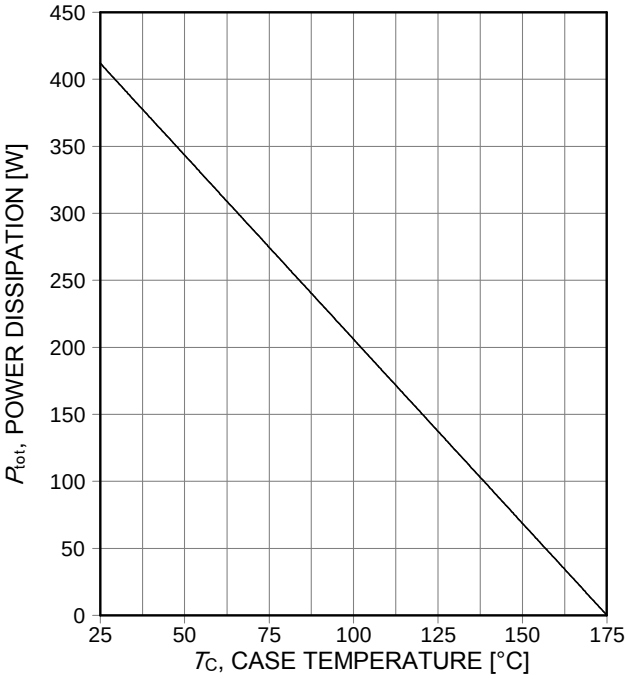

Figure 3. Power dissipation as a function of case temperature
(T_j≤175°C)

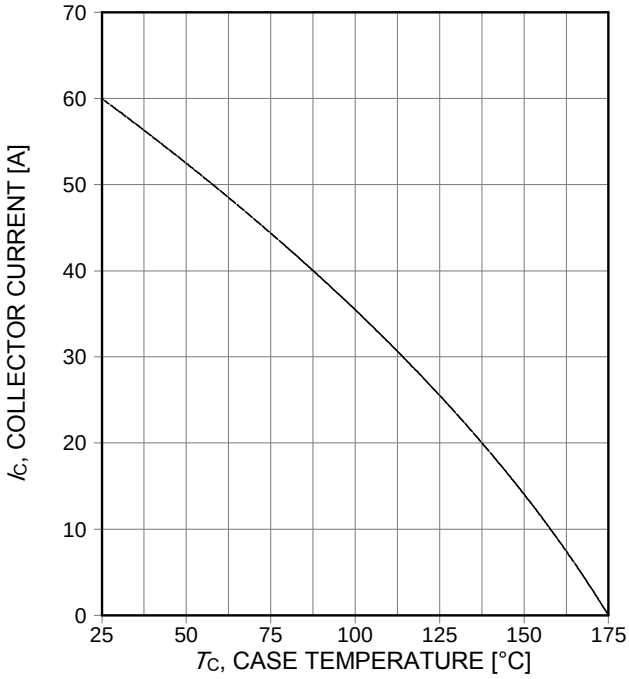

Figure 4. Collector current as a function of case temperature
(V_{GE}≥15V, T_j≤175°C)

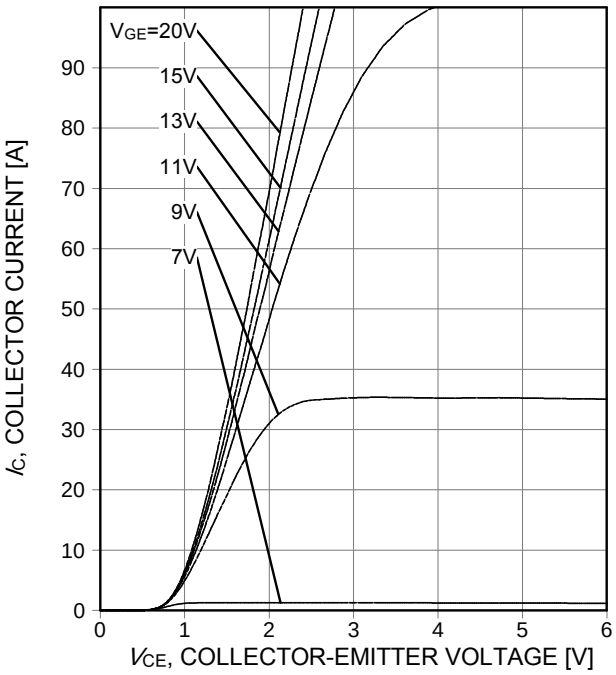

Figure 5. Typical output characteristic
(T_j=25°C)

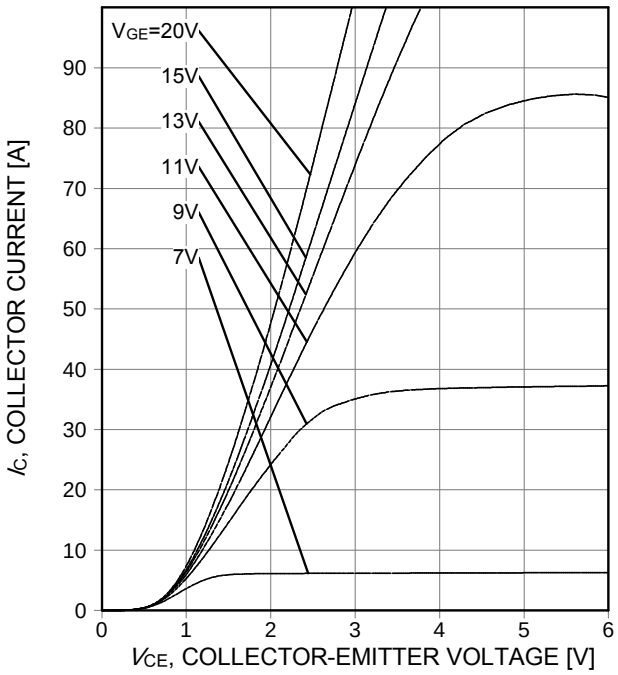

Figure 6. Typical output characteristic
(T_j=175°C)

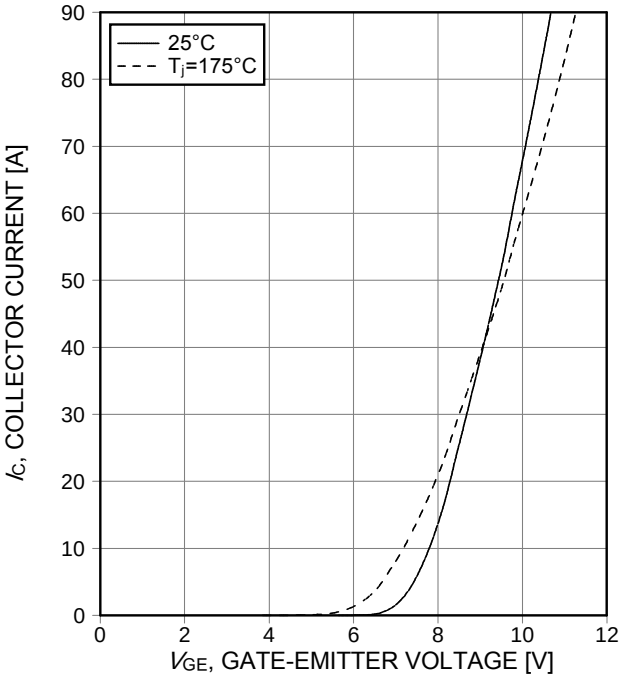

Figure 7. Typical transfer characteristic
(V_{CE}=20V)

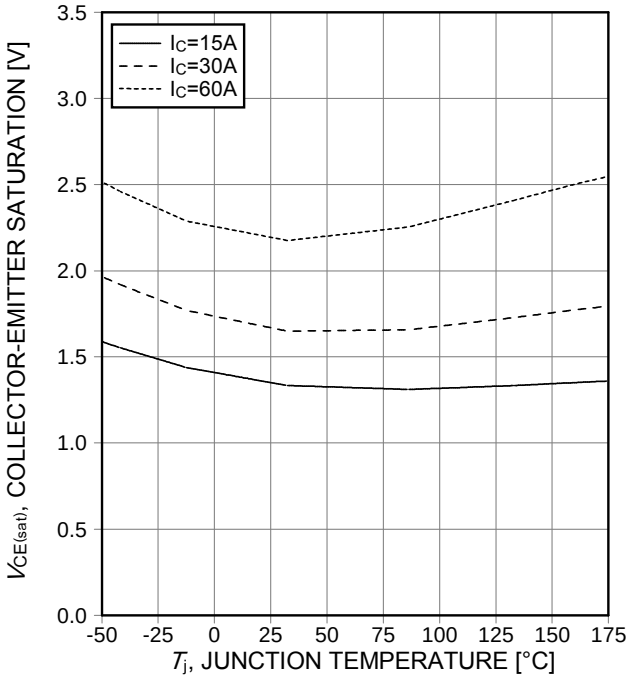

Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
(V_{GE}=15V)

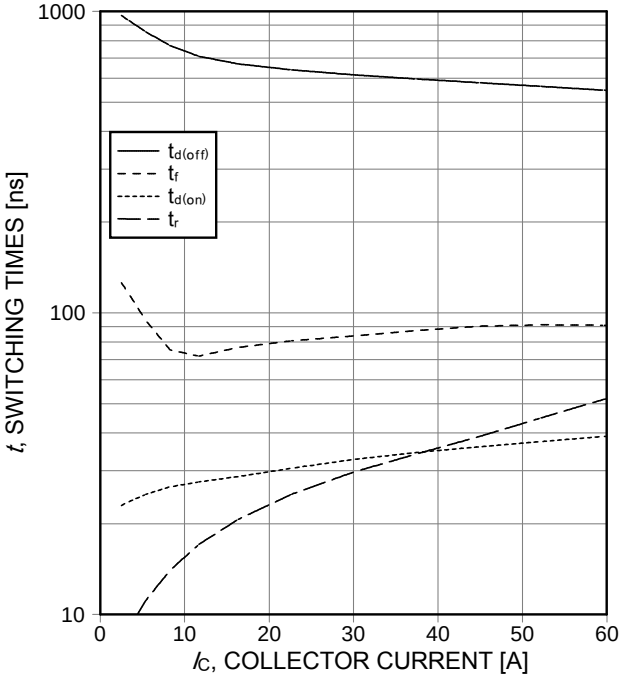

Figure 9. Typical switching times as a function of collector current
(inductive load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, R_G=16Ω,Dynamic test circuit in Figure E)

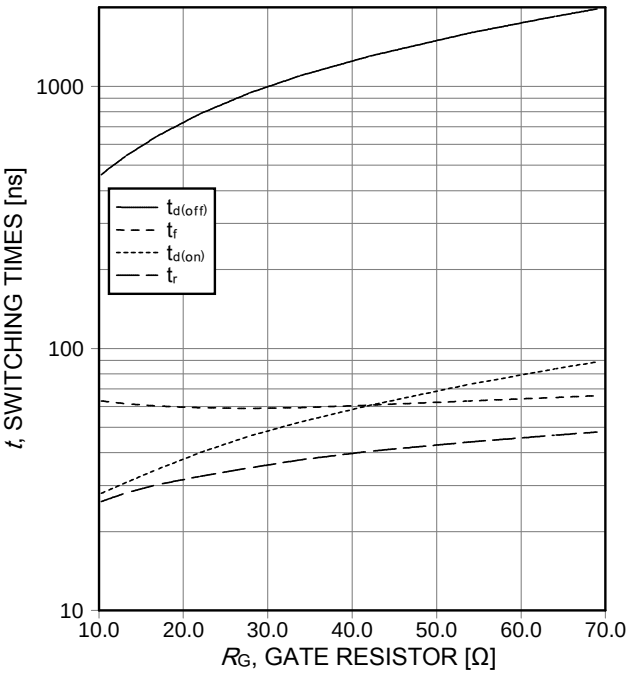

Figure 10. Typical switching times as a function of gate resistor
(inductive load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, I_C=30A,Dynamic test circuit in Figure E)

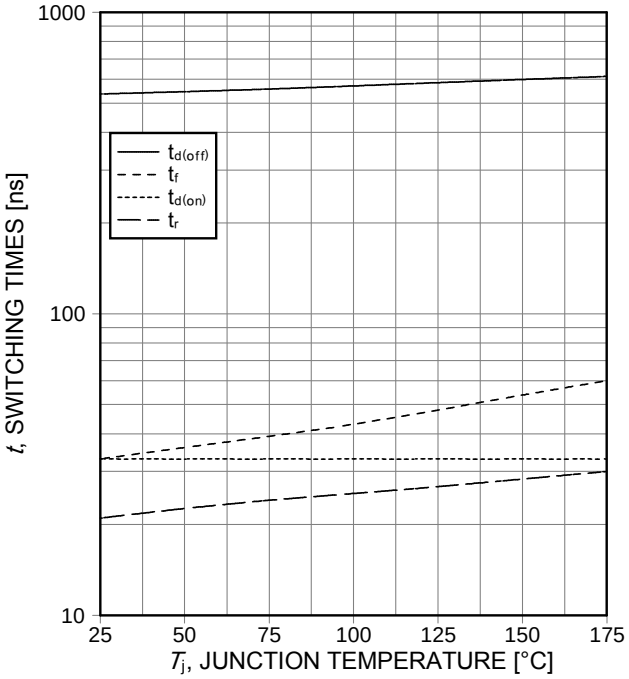

Figure 11. Typical switching times as a function of junction temperature
(inductive load, V_{CE}=600V, V_{GE}=15/0V, I_C=30A, R_G=16Ω,Dynamic test circuit in Figure E)

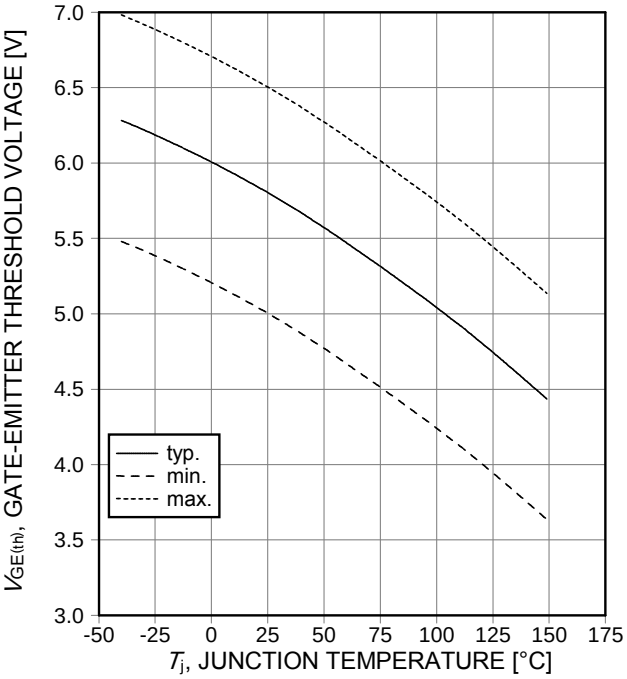

Figure 12. Gate-emitter threshold voltage as a function of junction temperature
(I_C=0.7mA)

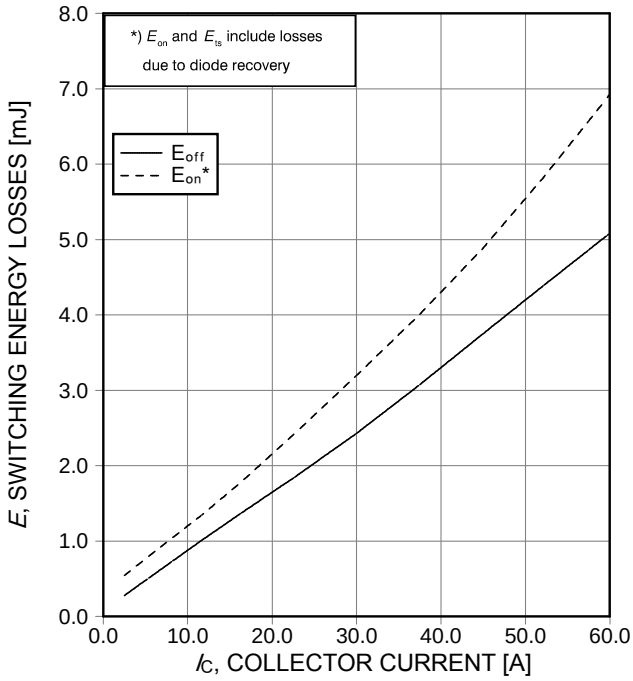

Figure 13. Typical switching energy losses as a function of collector current
(inductive load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, R_G=16Ω,Dynamic test circuit in Figure E)

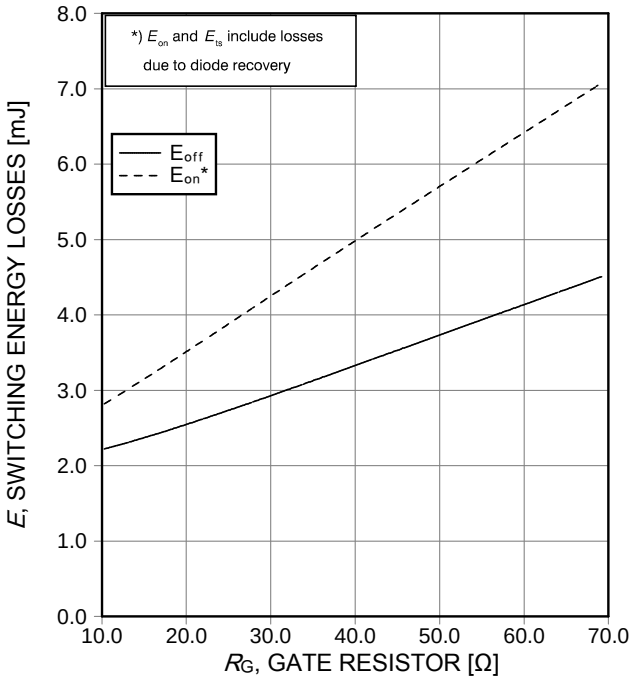

Figure 14. Typical switching energy losses as a function of gate resistor
(inductive load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, I_C=30A,Dynamic test circuit in Figure E)

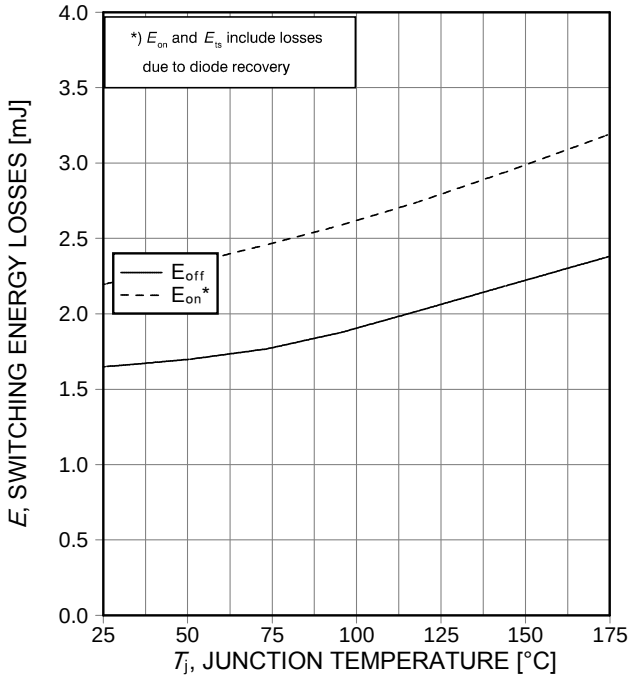

Figure 15. Typical switching energy losses as a function of junction temperature
(inductive load, V_{CE}=600V, V_{GE}=15/0V, I_C=30A, R_G=16Ω,Dynamic test circuit in Figure E)

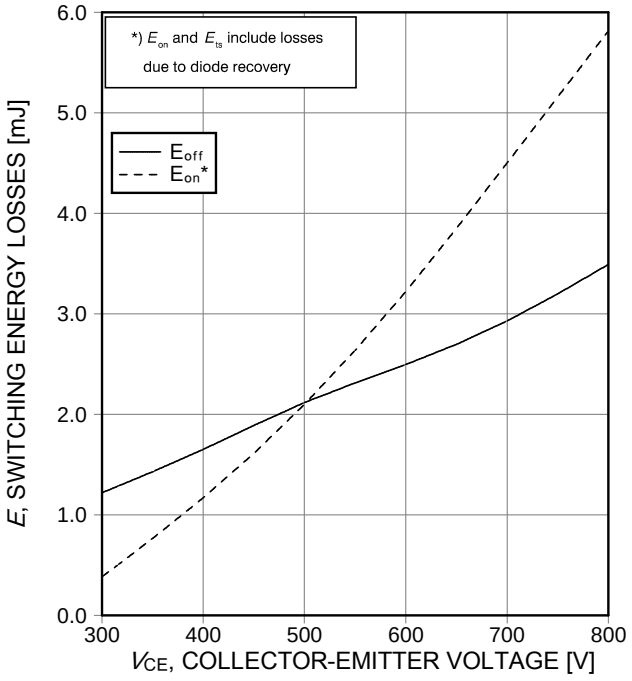

Figure 16. Typical switching energy losses as a function of collector emitter voltage
(inductive load, T_j=175°C, V_{GE}=15/0V, I_C=30A, R_G=16Ω,Dynamic test circuit in Figure E)

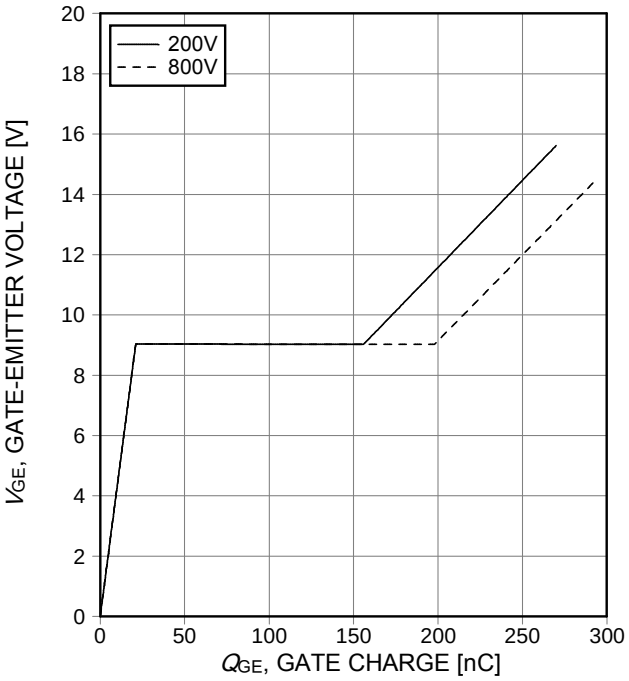

Figure 17. Typical gate charge
(I_C=30A)

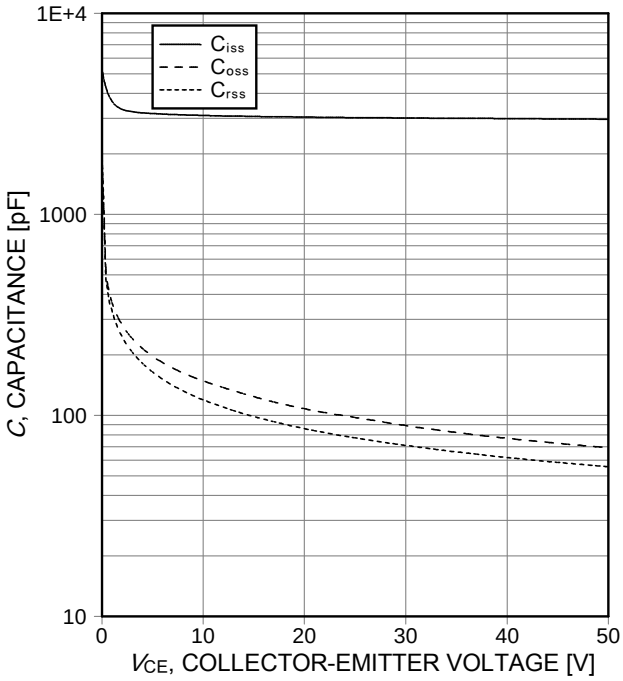

Figure 18. Typical capacitance as a function of collector-emitter voltage
(V_{GE}=0V, f=1MHz)

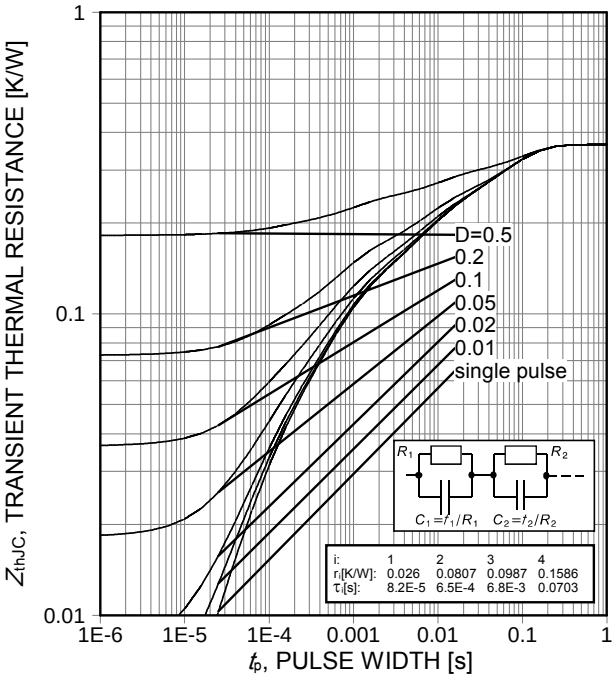

Figure 19. IGBT transient thermal resistance
($D=t_p/T$)

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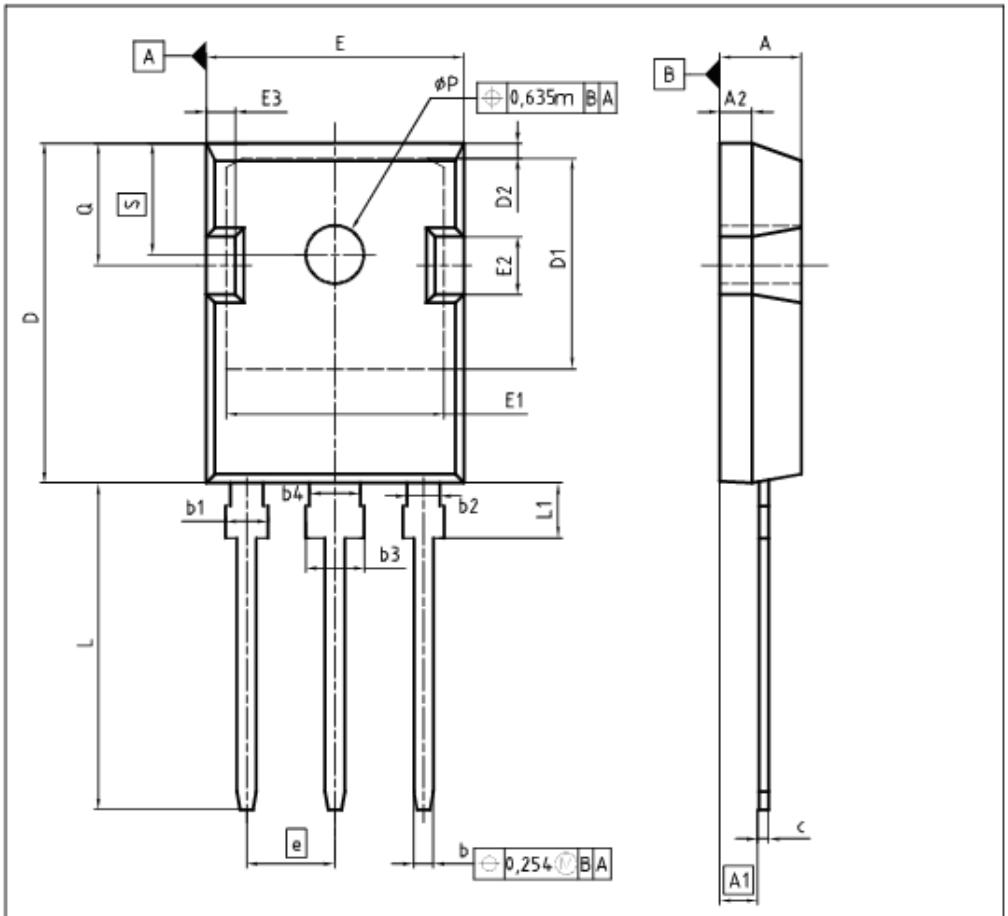

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44		0.214	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

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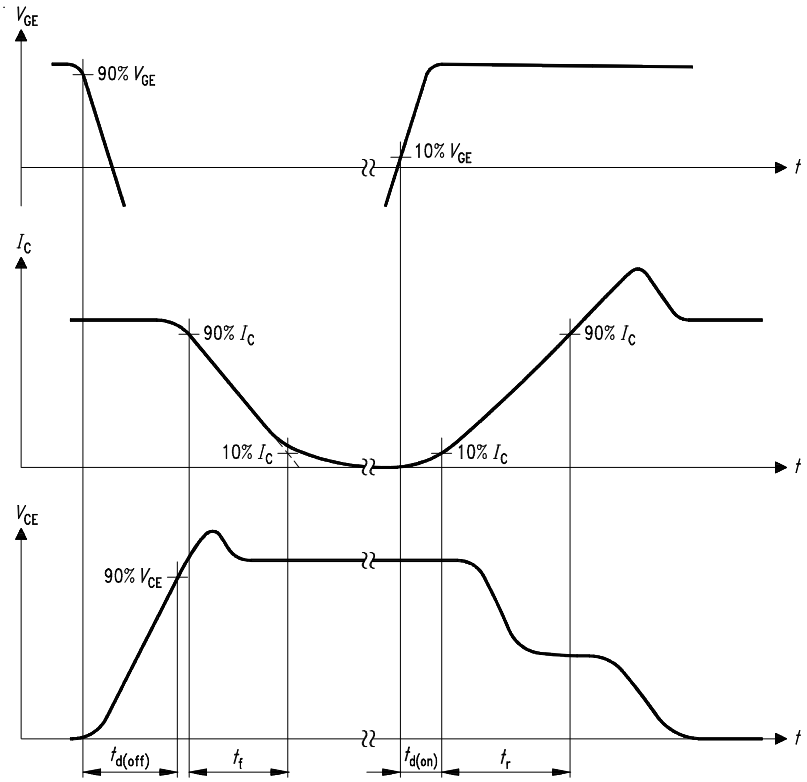

Figure A. Definition of switching times

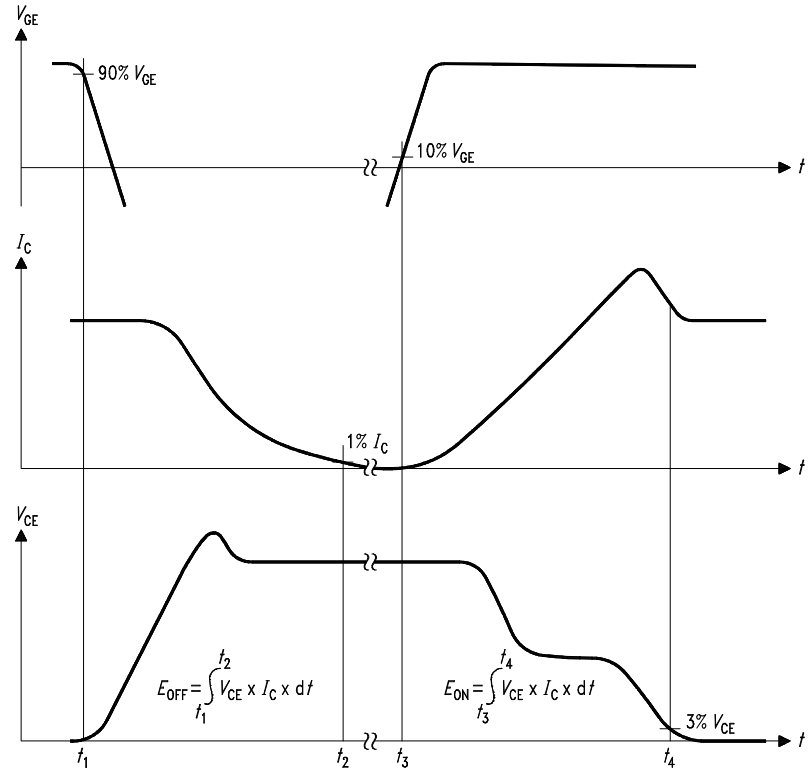

Figure B. Definition of switching losses

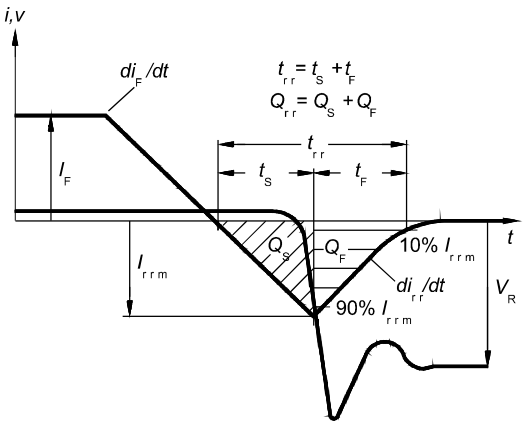

Figure C. Definition of diodes switching characteristics

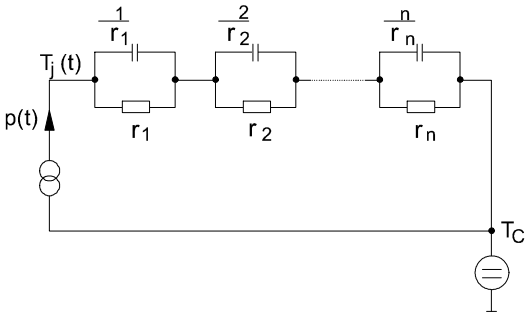

Figure D. Thermal equivalent circuit

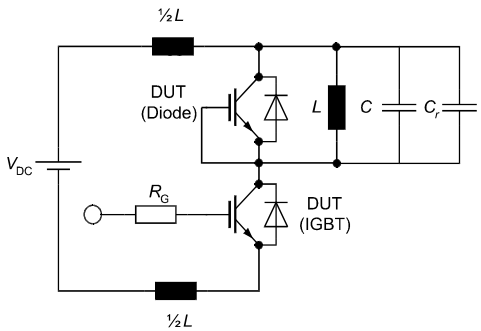

Figure E. Dynamic test circuit
Leakage inductance L= 180nH,
Stray capacitor C_σ = 40pF,
Relief capacitor C_r = 1nF
(only for ZVT switching)

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